

# VSTF065R11ANB

**Datasheet** 



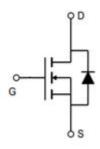


### VSTF065R11ANB

# **General Description**

V <sub>(BR)DSS</sub>	R <sub>DS(ON)_max</sub>	$I_D$
650V	110mΩ@10V	40A

# **Symbol**



 $Symbol\ of\ VSTF065R11ANB$ 

### **Features**

- Extremely low switching loss
- Excellent stability and uniformity
- RoHS and Halogen-Free Compliant
- Ultra-fast and robust body diode

# Application

- PC power
- LED lighting
- Telecom power
- Server power
- Solar/UPS

# Package Type



TO-247

Package Type of VSTF065R11ANB

# **Ordering Information**

<b>Product Name</b>	Package	Marking
VSTF065R11ANB	TO-247	VSTF065R11ANB



### VSTF065R11ANB

# Absolute Maximum Ratings(T<sub>J</sub>= 25 °C, unless otherwise specified)

Parameter		Symbol	Rating	Unit
Drain-Source Voltage  Gate-Source Voltage  Continuous Drain Current Note 1  Pulsed Drain Current Note 2  Continuous Diode Forward Current Note 1  Diode Pulsed Current Note 2		$V_{DS}$	650	V
Gate-Source Voltage		$V_{GS}$	±30	V
Continuous Drain Current Note 1	$T_C=25^{\circ}C$	$I_D$	40	A
Pulsed Drain Current Note 2	$T_C=25$ °C	I <sub>D, pulse</sub>	120	A
Continuous Diode Forward Current Note 1	$T_C=25^{\circ}C$	$I_S$	40	A
Diode Pulsed Current Note 2	$T_C=25$ °C	I <sub>S, pulse</sub>	120	A
Max Power Dissipation Note 3	$T_C=25^{\circ}C$	$P_{D}$	480	W
Avalanche Current, Single Pulse Note 4		I <sub>AS</sub>	9.8	A
Avalanche Energy, Single Pulse Note4		Eas	480	mJ
MOSFET dv/dt ruggedness, V <sub>DS</sub> =0~480V		dv/dt	50	V/ns
Reverse diode dv/dt, V <sub>DS</sub> =0~480V, I <sub>SD</sub> <= I <sub>D</sub>		dv/dt	15	V/ns
Operation and storage temperature		T <sub>J</sub> ,T <sub>STG</sub>	-55 to 150	°C

### **Thermal Resistance**

Parameter	Symbol	Min	Тур	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{ heta JC}$	-	0.26	-	°C/W
Thermal Resistance, Junction-to-Ambient Note5	$R_{ heta JA}$	-	62.5	-	C/W

#### **Notes:**

Note1: Calculated continuous current based on maximum allowable junction temperature.

Note2: Pulse width limited by safe operating area.

Note3: Based on max. junction temperature, using junction-case thermal resistance.

Note4:  $V_{DD}$ =50V,  $V_{GS}$ =10V, L=10mH, $R_G$ =25 $\Omega$ , starting  $T_A$ =25 °C.

Note5: When mounted on 1 inch square copper board, t≤10sec. The value in any given application depends on the user's specific board design.



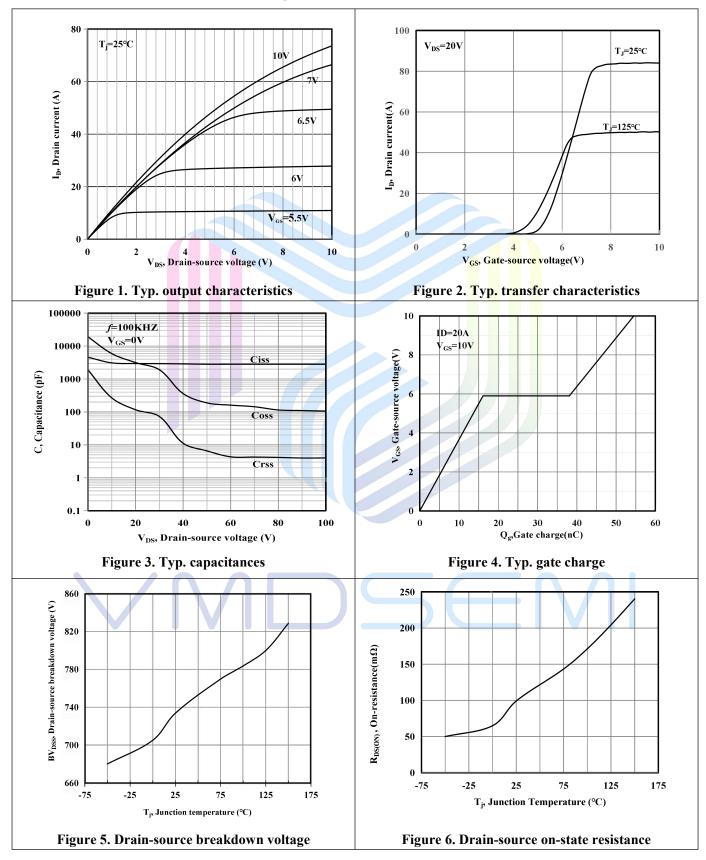
### VSTF065R11ANB

# **Electrical Characteristics** (T<sub>J</sub>= 25 °C, unless otherwise specified)

Parameter		Symbol	<b>Test Conditions</b>	Min	Тур	Max	Unit	
Statistic Characteristics				•				
Drain-Source Breakdown Voltage		$\mathrm{BV}_{\mathrm{DSS}}$	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	650	-	-	V	
Drain-Source Leakage Current		$I_{DSS}$	$V_{DS}$ =650V, $V_{GS}$ =0V	-	-	10	uA	
Cata Saymaa Laakaaa Cymmant	Forward	$I_{GSSF}$	$V_{GS}=30V, V_{DS}=0V$	-	-	100	A	
Gate-Source Leakage Current	Reverse	$I_{GSSR}$	$V_{GS}$ =-30V, $V_{DS}$ =0V	-	-	-100	nA	
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$ , $I_{D}=250uA$	3	4.0	5	V	
Drain-Source On-State Resistance	ce	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =15A	-	92	110	mΩ	
Gate Resistance		$R_G$	F=1MHz, Open Drain	-	3.3	-	Ω	
Dynamic Characteristics								
Input Capacitance		C <sub>iss</sub>	V <sub>DS</sub> =50V		2818	-	pF	
Output Capacitance		Coss	V <sub>GS</sub> =0V	-	188.6	-	pF	
Reverse Transfer Capacitance		$C_{rss}$	f=100kHz	-	6.57	-	pF	
Turn-on Delay Time		t <sub>d(on)</sub>	V <sub>DS</sub> =400V	-	19.49	-		
Rise Time		$t_{\rm r}$	I <sub>D</sub> =20A	-	10.16	-	<b>12</b> G	
Turn-off Delay Time		$t_{ m d(off)}$	$R_G=2\Omega$	-	48.88	-	ns	
Fall Time		$t_{\mathrm{f}}$	V <sub>GS</sub> =10V	-	5.78	-		
Gate Charge Characteristics								
Gate to Source Charge		$Q_{gs}$	V -400V	7-1	16.1	-		
Gate to Drain Charge		$Q_{\mathrm{gd}}$	$V_{DS}$ =400V $I_{D}$ =20A	-/-	21.98	_	nC	
Gate Charge Total		$Q_{\mathrm{g}}$	$V_{GS}=0$ to $10V$	-	54.5	-		
Gate Plateau Voltage		$V_{Plateau}$	V GS-0 to 10 V	-	5.9	-	V	
Reverse Diode Characteristics								
Drain-Source Diode Forward Vo	ltage	$ m V_{SD}$	$V_{GS}=0V, I_{S}=1A$	-	0.67	1.4	V	
Reverse Recovery Time		$t_{rr}$	V <sub>R</sub> =400V	-	128	-	ns	
Reverse Recovery Charge		Qrr	$I_{\rm S}=20A$	-	819	-	пC	
Peak Reverse Recovery Current		I <sub>rrm</sub>	di/dt=100A/us	<u> </u>	11.97	7-1	A	
			5		V			

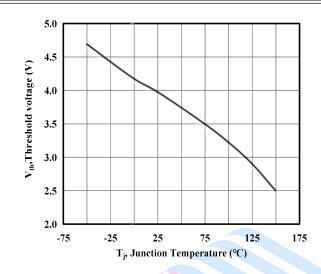


# **Electrical Characteristics Diagrams**





### VSTF065R11ANB



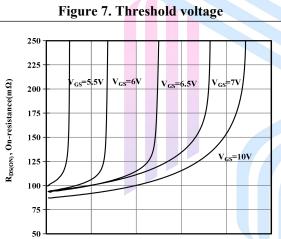


Figure 9. Drain-source on-state resistance

40 60 I<sub>D</sub>, Drain current(A)

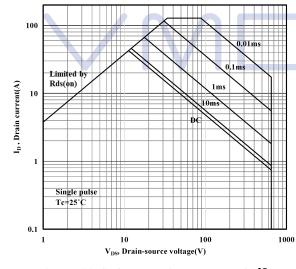


Figure 11. Safe operation area T<sub>c</sub>=25℃

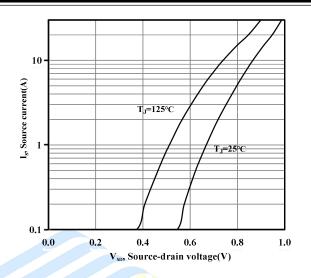


Figure 8. Forward characteristic of body diode

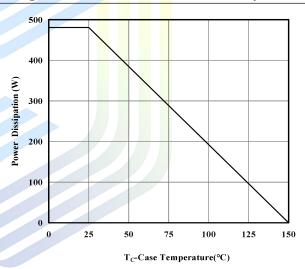


Figure 10. Power dissipation

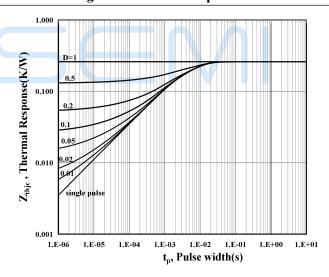


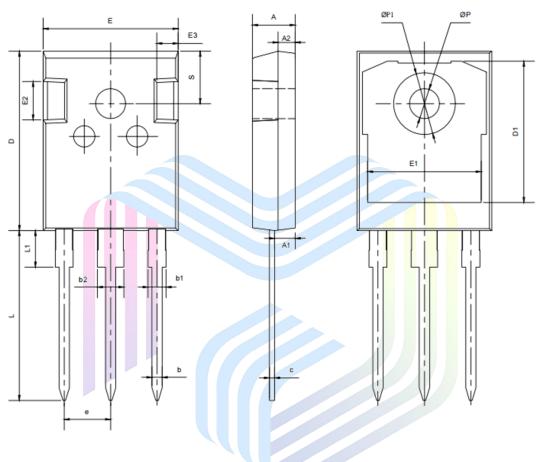
Figure 12. Max. transient thermal impedance

100



# **Mechanical Dimensions**

**TO-247 Package Information** 



COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	MAX				
Α	4.80	5.20				
A1	2.21	2.61				
A2	1.85	2.15				
b	1.11	1.36				
b1	1.91	2.21				
b2	2.91	3.21				
С	0.51	0.75				
D	20.70	21.30				
D1	16.25	16.85				
E	15.50	16.10				
E1	13.00	13.60				
E2	4.80	5.60				
E3	2.10	2.70				
e	5.44	BSC				
L	19.62	20.22				
L1	-	4.30				
φР	3.40	3.80				
φP1	-	7.30				
S	6.15	BSC				

### 110mΩ, 650V, N-Channel Power MOSFET

VSTF065R11ANB

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